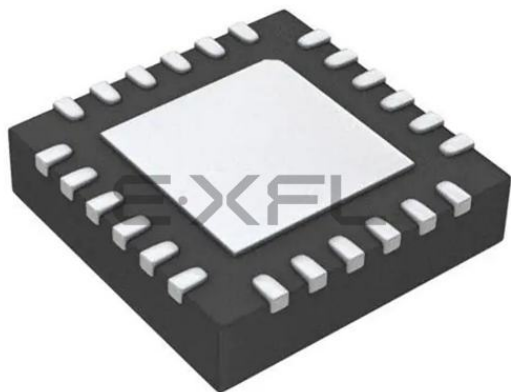




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Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	21
Program Memory Size	16KB (16K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	1.25K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	24-WFQFN Exposed Pad
Supplier Device Package	24-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051t617-gmr

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5. QFN-28 Package Specifications

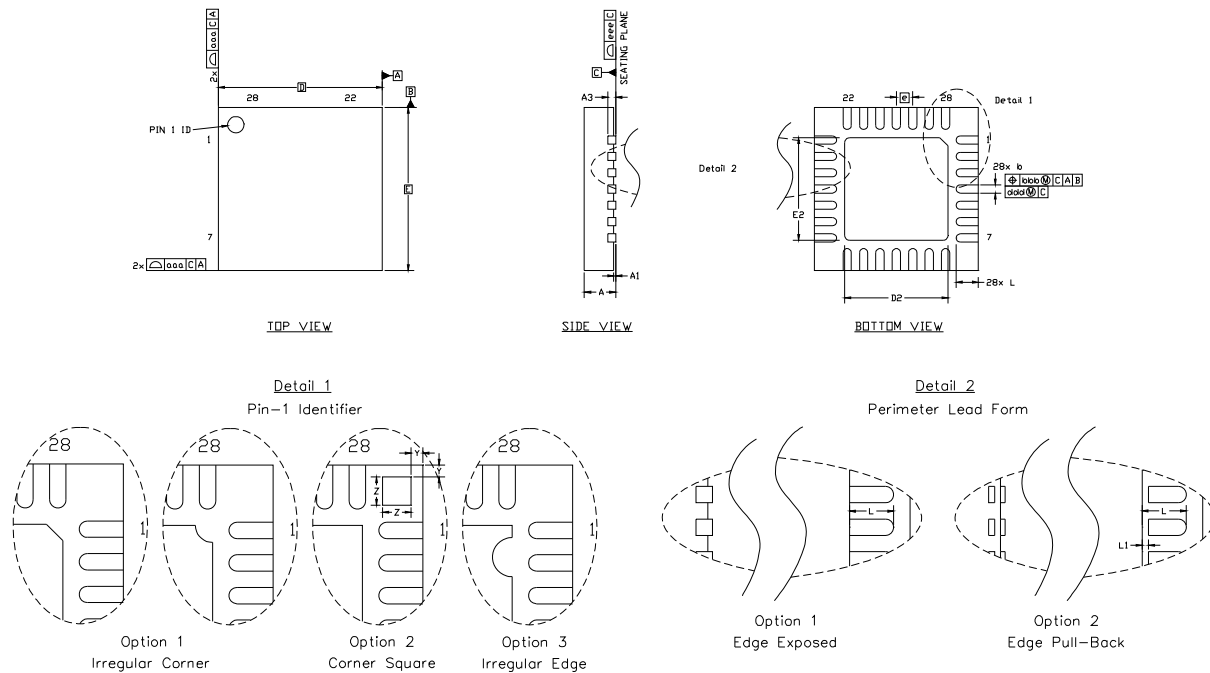


Figure 5.1. QFN-28 Package Drawing

Table 5.1. QFN-28 Package Dimensions

Dimension	Min	Typ	Max
A	0.80	0.90	1.00
A1	0.00	0.02	0.05
A3	0.25 REF		
b	0.18	0.23	0.30
D	5.00 BSC.		
D2	2.90	3.15	3.35
e	0.50 BSC.		
E	5.00 BSC.		
E2	2.90	3.15	3.35
L	0.35	0.55	0.65
L1	0.00	—	0.15
aaa	0.15		
bbb	0.10		
ddd	0.05		
eee	0.08		
Z	0.44		
Y	0.18		

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to the JEDEC Solid State Outline MO-220, variation VHHD except for custom features D2, E2, Z, Y, and L which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

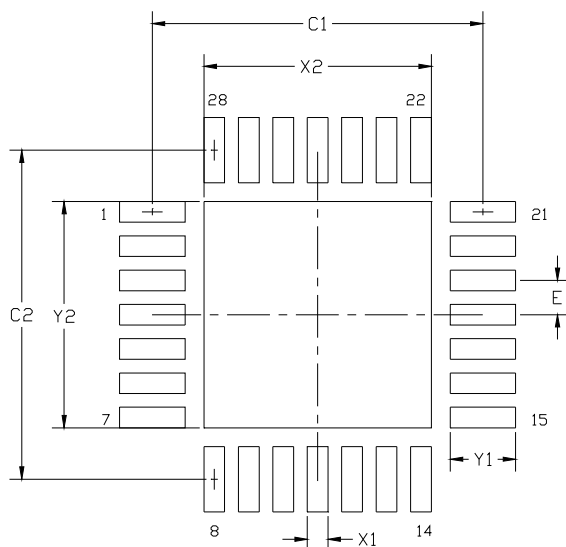


Figure 5.2. QFN-28 Recommended PCB Land Pattern

Table 5.2. QFN-28 PCB Land Pattern Dimesions

Dimension	Min	Max
C1	4.80	
C2	4.80	
E	0.50	
X1	0.20	0.30

Dimension	Min	Max
X2	3.20	3.30
Y1	0.85	0.95
Y2	3.20	3.30

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
3. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

4. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60µm minimum, all the way around the pad.

Stencil Design

5. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
6. The stencil thickness should be 0.125mm (5 mils).
7. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pins.
8. A 3x3 array of 0.90mm openings on a 1.1mm pitch should be used for the center pad to assure the proper paste volume.

Card Assembly

9. A No-Clean, Type-3 solder paste is recommended.
10. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

6. QFN-24 Package Specifications

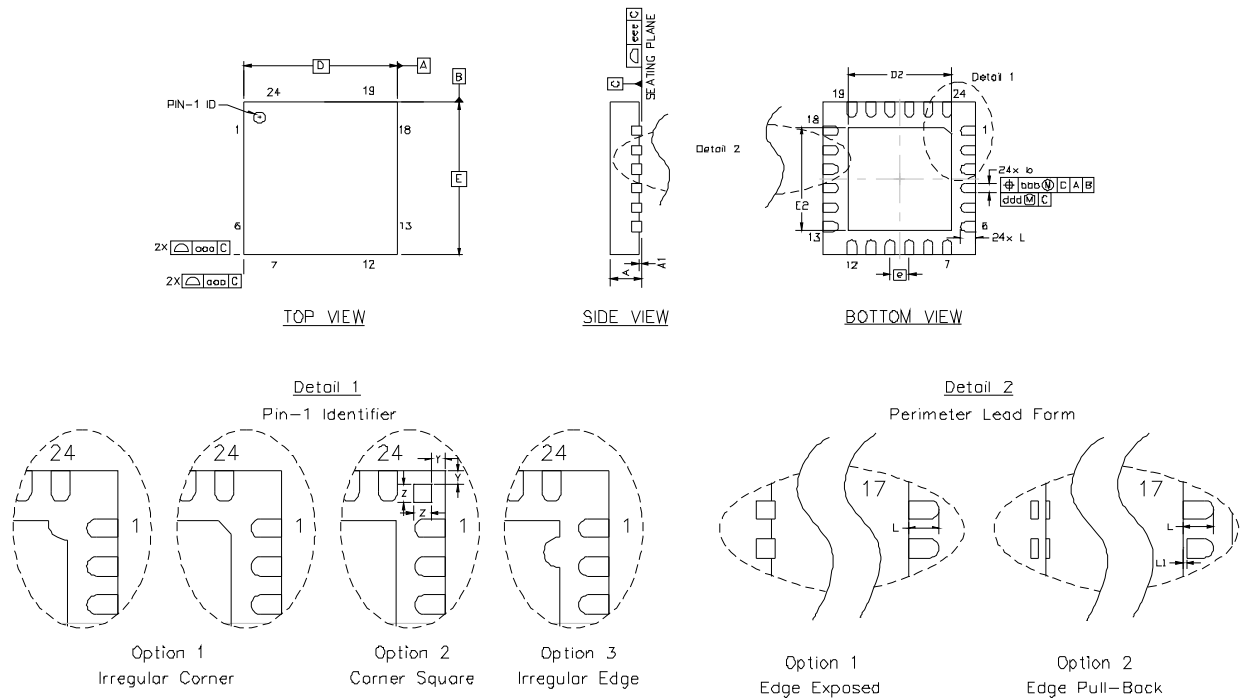


Figure 6.1. QFN-24 Package Drawing

Table 6.1. QFN-24 Package Dimensions

Dimension	Min	Typ	Max
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D	4.00 BSC.		
D2	2.55	2.70	2.80
e	0.50 BSC.		
E	4.00 BSC.		
E2	2.55	2.70	2.80

Dimension	Min	Typ	Max
L	0.30	0.40	0.50
L1	0.00	—	0.15
aaa	—	—	0.15
bbb	—	—	0.10
ddd	—	—	0.05
eee	—	—	0.08
Z	—	0.24	—
Y	—	0.18	—

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC Solid State Outline MO-220, variation WGGD except for custom features D2, E2, Z, Y, and L which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

Table 7.11. Comparator Electrical Characteristics

$V_{DD} = 3.0\text{ V}$, -40 to $+85\text{ }^{\circ}\text{C}$ unless otherwise noted.

Parameter	Conditions	Min	Typ	Max	Units
Response Time: Mode 0, $V_{cm}^* = 1.5\text{ V}$	$CP0+ - CP0- = 100\text{ mV}$	—	240	—	ns
	$CP0+ - CP0- = -100\text{ mV}$	—	240	—	ns
Response Time: Mode 1, $V_{cm}^* = 1.5\text{ V}$	$CP0+ - CP0- = 100\text{ mV}$	—	400	—	ns
	$CP0+ - CP0- = -100\text{ mV}$	—	400	—	ns
Response Time: Mode 2, $V_{cm}^* = 1.5\text{ V}$	$CP0+ - CP0- = 100\text{ mV}$	—	650	—	ns
	$CP0+ - CP0- = -100\text{ mV}$	—	1100	—	ns
Response Time: Mode 3, $V_{cm}^* = 1.5\text{ V}$	$CP0+ - CP0- = 100\text{ mV}$	—	2000	—	ns
	$CP0+ - CP0- = -100\text{ mV}$	—	5500	—	ns
Common-Mode Rejection Ratio		—	1	4	mV/V
Positive Hysteresis 1	$CP0HYP1-0 = 00$	—	0	1	mV
Positive Hysteresis 2	$CP0HYP1-0 = 01$	2	5	8	mV
Positive Hysteresis 3	$CP0HYP1-0 = 10$	6	10	14	mV
Positive Hysteresis 4	$CP0HYP1-0 = 11$	12	20	28	mV
Negative Hysteresis 1	$CP0HYN1-0 = 00$	—	0	1	mV
Negative Hysteresis 2	$CP0HYN1-0 = 01$	2	5	8	mV
Negative Hysteresis 3	$CP0HYN1-0 = 10$	6	10	14	mV
Negative Hysteresis 4	$CP0HYN1-0 = 11$	12	20	28	mV
Inverting or Non-Inverting Input Voltage Range		-0.25	—	$V_{DD} + 0.25$	V
Input Offset Voltage		-7.5	—	7.5	mV
Power Specifications					
Power Supply Rejection		—	0.5	—	mV/V
Powerup Time		—	10	—	μs
Supply Current at DC	Mode 0	—	26	50	μA
	Mode 1	—	10	20	μA
	Mode 2	—	3	6	μA
	Mode 3	—	0.5	2	μA
Note: V_{cm} is the common-mode voltage on $CP0+$ and $CP0-$.					

12. Comparator0 and Comparator1

C8051T610/1/2/3/4/5/6/7 devices include two on-chip programmable voltage comparators: Comparator0 is shown in Figure 12.1, Comparator1 is shown in Figure 12.2. The two comparators operate identically with the following exceptions: (1) Their input selections differ as described in Section “12.1. Comparator Multiplexers” on page 65; (2) Comparator0 can be used as a reset source.

The Comparators offer programmable response time and hysteresis, an analog input multiplexer, and two outputs that are optionally available at the Port pins: a synchronous “latched” output (CP0 or CP1), or an asynchronous “raw” output (CP0A or CP1A). The asynchronous signals are available even when the system clock is not active. This allows the Comparators to operate and generate an output with the device in STOP mode. When assigned to a Port pin, the Comparator outputs may be configured as open drain or push-pull (see Section “21.4. Port I/O Initialization” on page 121). Comparator0 may also be used as a reset source (see Section “19.5. Comparator0 Reset” on page 104).

The Comparator inputs are selected by the comparator input multiplexers, as detailed in Section “12.1. Comparator Multiplexers” on page 65.

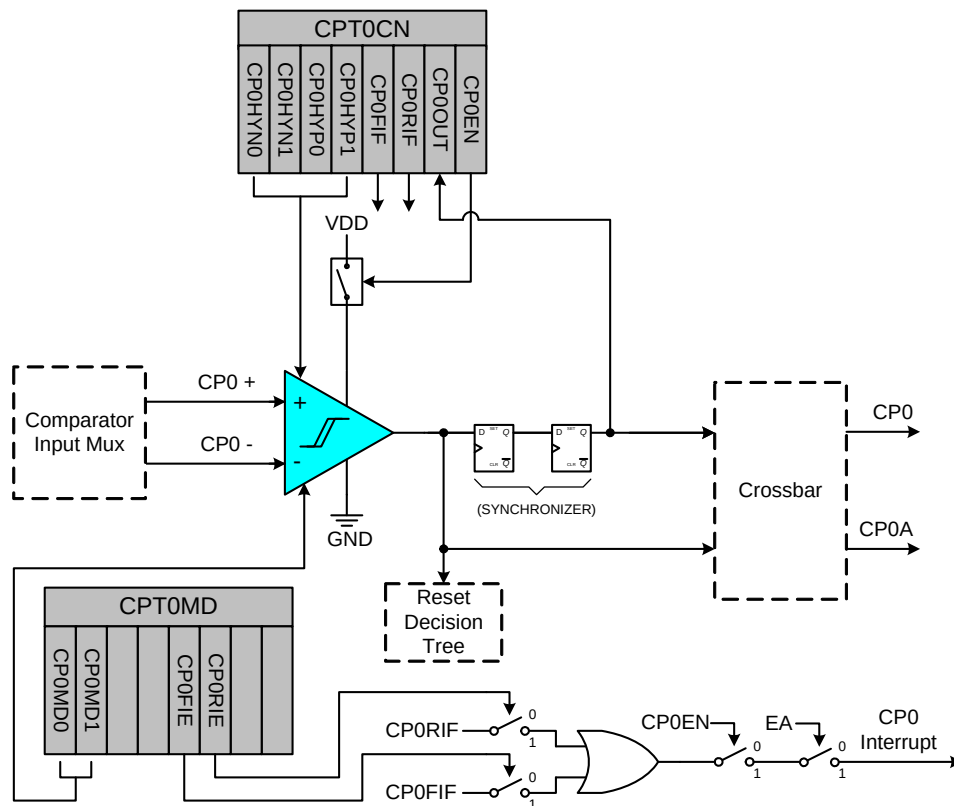


Figure 12.1. Comparator0 Functional Block Diagram

SFR Definition 12.2. CPT0MD: Comparator0 Mode Selection

Bit	7	6	5	4	3	2	1	0
Name			CP0RIE	CP0FIE			CP0MD[1:0]	
Type	R	R	R/W	R/W	R	R	R/W	
Reset	0	0	0	0	0	0	1	0

SFR Address = 0x9D

Bit	Name	Function
7:6	Unused	Unused. Read = 00b, Write = Don't Care.
5	CP0RIE	Comparator0 Rising-Edge Interrupt Enable. 0: Comparator0 Rising-edge interrupt disabled. 1: Comparator0 Rising-edge interrupt enabled.
4	CP0FIE	Comparator0 Falling-Edge Interrupt Enable. 0: Comparator0 Falling-edge interrupt disabled. 1: Comparator0 Falling-edge interrupt enabled.
3:2	Unused	Unused. Read = 00b, Write = don't care.
1:0	CP0MD[1:0]	Comparator0 Mode Select. These bits affect the response time and power consumption for Comparator0. 00: Mode 0 (Fastest Response Time, Highest Power Consumption) 01: Mode 1 10: Mode 2 11: Mode 3 (Slowest Response Time, Lowest Power Consumption)

14.2.1.1. General Purpose Registers

The lower 32 bytes of data memory, locations 0x00 through 0x1F, may be addressed as four banks of general-purpose registers. Each bank consists of eight byte-wide registers designated R0 through R7. Only one of these banks may be enabled at a time. Two bits in the program status word, RS0 (PSW.3) and RS1 (PSW.4), select the active register bank (see description of the PSW in SFR Definition 13.6). This allows fast context switching when entering subroutines and interrupt service routines. Indirect addressing modes use registers R0 and R1 as index registers.

14.2.1.2. Bit Addressable Locations

In addition to direct access to data memory organized as bytes, the sixteen data memory locations at 0x20 through 0x2F are also accessible as 128 individually addressable bits. Each bit has a bit address from 0x00 to 0x7F. Bit 0 of the byte at 0x20 has bit address 0x00 while bit7 of the byte at 0x20 has bit address 0x07. Bit 7 of the byte at 0x2F has bit address 0x7F. A bit access is distinguished from a full byte access by the type of instruction used (bit source or destination operands as opposed to a byte source or destination).

The MCS-51™ assembly language allows an alternate notation for bit addressing of the form XX.B where XX is the byte address and B is the bit position within the byte. For example, the instruction:

```
MOV    C, 22.3h
```

moves the Boolean value at 0x13 (bit 3 of the byte at location 0x22) into the Carry flag.

14.2.1.3. Stack

A programmer's stack can be located anywhere in the 256-byte data memory. The stack area is designated using the Stack Pointer (SP) SFR. The SP will point to the last location used. The next value pushed on the stack is placed at SP+1 and then SP is incremented. A reset initializes the stack pointer to location 0x07. Therefore, the first value pushed on the stack is placed at location 0x08, which is also the first register (R0) of register bank 1. Thus, if more than one register bank is to be used, the SP should be initialized to a location in the data memory not being used for data storage. The stack depth can extend up to 256 bytes.

14.2.2. External RAM

There are 1024 bytes of on-chip RAM mapped into the external data memory space. All of these address locations may be accessed using the external move instruction (MOVX) and the data pointer (DPTR), or using MOVX indirect addressing mode. If the MOVX instruction is used with an 8-bit address operand (such as @R1), then the high byte of the 16-bit address is provided by the External Memory Interface Control Register (EMI0CN as shown in SFR Definition 14.1).

For a 16-bit MOVX operation (@DPTR), the upper 7 bits of the 16-bit external data memory address word are "don't cares". As a result, the 1024-byte RAM is mapped modulo style over the entire 64 k external data memory address range. For example, the XRAM byte at address 0x0000 is shadowed at addresses 0x0400, 0x0800, 0x0C00, 0x1000, etc. This is a useful feature when performing a linear memory fill, as the address pointer doesn't have to be reset when reaching the RAM block boundary.

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Table 15.2. Special Function Registers

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
ACC	0xE0	Accumulator	75
ADC0CF	0xBC	ADC0 Configuration	43
ADC0CN	0xE8	ADC0 Control	45
ADC0GTH	0xC4	ADC0 Greater-Than Compare High	46
ADC0GTL	0xC3	ADC0 Greater-Than Compare Low	46
ADC0H	0xBE	ADC0 High	44
ADC0L	0xBD	ADC0 Low	44
ADC0LTH	0xC6	ADC0 Less-Than Compare Word High	47
ADC0LTL	0xC5	ADC0 Less-Than Compare Word Low	47
AMX0P	0xBB	AMUX0 Positive Channel Select	50
B	0xF0	B Register	75
CKCON	0x8E	Clock Control	171
CLKSEL	0xA9	Clock Select	107
CPT0CN	0x9B	Comparator0 Control	61
CPT0MD	0x9D	Comparator0 Mode Selection	62
CPT0MX	0x9F	Comparator0 MUX Selection	66
CPT1CN	0x9A	Comparator1 Control	63
CPT1MD	0x9C	Comparator1 Mode Selection	64
CPT1MX	0x9E	Comparator1 MUX Selection	67
DPH	0x83	Data Pointer High	74
DPL	0x82	Data Pointer Low	74
EIE1	0xE6	Extended Interrupt Enable 1	90
EIP1	0xF6	Extended Interrupt Priority 1	91
EMIOCN	0xAA	External Memory Interface Control	80
IE	0xA8	Interrupt Enable	88
IP	0xB8	Interrupt Priority	89
IT01CF	0xE4	INT0/INT1 Configuration	93
OSCICL	0xB3	Internal Oscillator Calibration	108
OSCICN	0xB2	Internal Oscillator Control	109
OSCXCN	0xB1	External Oscillator Control	111
P0	0x80	Port 0 Latch	124
P0MDIN	0xF1	Port 0 Input Mode Configuration	125
P0MDOUT	0xA4	Port 0 Output Mode Configuration	125

SFR Definition 16.4. EIP1: Extended Interrupt Priority 1

Bit	7	6	5	4	3	2	1	0
Name	PT3	PCP1	PCP0	PPCA0	PADC0	PWADC0	Reserved	PSMB0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF6

Bit	Name	Function
7	PT3	Timer 3 Interrupt Priority Control. This bit sets the priority of the Timer 3 interrupt. 0: Timer 3 interrupts set to low priority level. 1: Timer 3 interrupts set to high priority level.
6	PCP1	Comparator1 (CP1) Interrupt Priority Control. This bit sets the priority of the CP1 interrupt. 0: CP1 interrupt set to low priority level. 1: CP1 interrupt set to high priority level.
5	PCP0	Comparator0 (CP0) Interrupt Priority Control. This bit sets the priority of the CP0 interrupt. 0: CP0 interrupt set to low priority level. 1: CP0 interrupt set to high priority level.
4	PPCA0	Programmable Counter Array (PCA0) Interrupt Priority Control. This bit sets the priority of the PCA0 interrupt. 0: PCA0 interrupt set to low priority level. 1: PCA0 interrupt set to high priority level.
3	PADC0	ADC0 Conversion Complete Interrupt Priority Control. This bit sets the priority of the ADC0 Conversion Complete interrupt. 0: ADC0 Conversion Complete interrupt set to low priority level. 1: ADC0 Conversion Complete interrupt set to high priority level.
2	PWADC0	ADC0 Window Comparator Interrupt Priority Control. This bit sets the priority of the ADC0 Window interrupt. 0: ADC0 Window interrupt set to low priority level. 1: ADC0 Window interrupt set to high priority level.
1	Reserved	Reserved. Must Write 0.
0	PSMB0	SMBus (SMB0) Interrupt Priority Control. This bit sets the priority of the SMB0 interrupt. 0: SMB0 interrupt set to low priority level. 1: SMB0 interrupt set to high priority level.

SFR Definition 18.1. PCON: Power Control

Bit	7	6	5	4	3	2	1	0
Name	GF[5:0]						STOP	IDLE
Type	R/W						R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x87

Bit	Name	Function
7:2	GF[5:0]	General Purpose Flags 5–0. These are general purpose flags for use under software control.
1	STOP	Stop Mode Select. Setting this bit will place the CIP-51 in Stop mode. This bit will always be read as 0. 1: CPU goes into Stop mode (internal oscillator stopped).
0	IDLE	Idle Mode Select. Setting this bit will place the CIP-51 in Idle mode. This bit will always be read as 0. 1: CPU goes into Idle mode. (Shuts off clock to CPU, but clock to Timers, Interrupts, Serial Ports, and Analog Peripherals are still active.)

19. Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. On entry to this reset state, the following occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External Port pins are forced to a known state
- Interrupts and timers are disabled

All SFRs are reset to the predefined values noted in the SFR detailed descriptions. The contents of internal data memory are unaffected during a reset; any previously stored data is preserved. However, since the stack pointer SFR is reset, the stack is effectively lost, even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain mode. Weak pullups are enabled during and after the reset. For V_{DD} Monitor and power-on resets, the RST pin is driven low until the device exits the reset state.

On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to the internal oscillator. The Watchdog Timer is enabled with the system clock divided by 12 as its clock source. Program execution begins at location 0x0000.

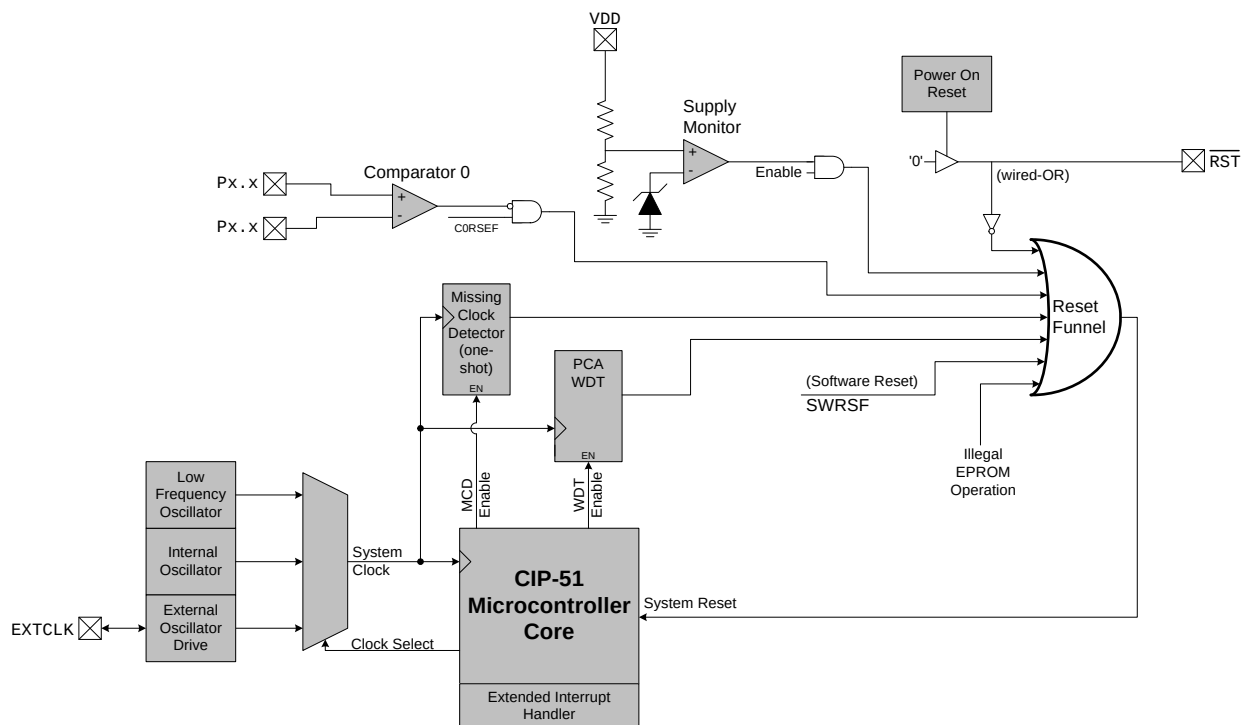


Figure 19.1. Reset Sources

21.1. Port I/O Modes of Operation

Port pins use the Port I/O cell shown in Figure 21.2. Each Port I/O cell can be configured by software for analog I/O or digital I/O using the PnMDIN registers. On reset, all Port I/O cells default to a high impedance state with weak pull-ups enabled until the Crossbar is enabled (XBARE = 1).

21.1.1. Port Pins Configured for Analog I/O

Any pins to be used as Comparator or ADC input, external oscillator input/output, or VREF should be configured for analog I/O (PnMDIN.n = 1). When a pin is configured for analog I/O, its weak pullup, digital driver, and digital receiver are disabled. Port pins configured for analog I/O will always read back a value of 0.

Configuring pins as analog I/O saves power and isolates the Port pin from digital interference. Port pins configured as digital inputs may still be used by analog peripherals; however, this practice is not recommended and may result in measurement errors.

21.1.2. Port Pins Configured For Digital I/O

Any pins to be used by digital peripherals (UART, SPI, SMBus, etc.), external digital event capture functions, or as GPIO should be configured as digital I/O (PnMDIN.n = 1). For digital I/O pins, one of two output modes (push-pull or open-drain) must be selected using the PnMDOUT registers.

Push-pull outputs (PnMDOUT.n = 1) drive the Port pad to the VDD or GND supply rails based on the output logic value of the Port pin. Open-drain outputs have the high side driver disabled; therefore, they only drive the Port pad to GND when the output logic value is 0 and become high impedance inputs (both high low drivers turned off) when the output logic value is 1.

When a digital I/O cell is placed in the high impedance state, a weak pull-up transistor pulls the Port pad to the VDD supply voltage to ensure the digital input is at a defined logic state. Weak pull-ups are disabled when the I/O cell is driven to GND to minimize power consumption and may be globally disabled by setting WEAKPUD to 1. The user should ensure that digital I/O are always internally or externally pulled or driven to a valid logic state to minimize power consumption. Port pins configured for digital I/O always read back the logic state of the Port pad, regardless of the output logic value of the Port pin.

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SFR Definition 23.1. SCON0: Serial Port 0 Control

Bit	7	6	5	4	3	2	1	0
Name	S0MODE		MCE0	REN0	TB80	RB80	TI0	RI0
Type	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	1	0	0	0	0	0	0

SFR Address = 0x98; Bit-Addressable

Bit	Name	Function
7	S0MODE	Serial Port 0 Operation Mode. Selects the UART0 Operation Mode. 0: 8-bit UART with Variable Baud Rate. 1: 9-bit UART with Variable Baud Rate.
6	Unused	Unused. Read = 1b, Write = Don't Care.
5	MCE0	Multiprocessor Communication Enable. The function of this bit is dependent on the Serial Port 0 Operation Mode: Mode 0: Checks for valid stop bit. 0: Logic level of stop bit is ignored. 1: RI0 will only be activated if stop bit is logic level 1. Mode 1: Multiprocessor Communications Enable. 0: Logic level of ninth bit is ignored. 1: RI0 is set and an interrupt is generated only when the ninth bit is logic 1.
4	REN0	Receive Enable. 0: UART0 reception disabled. 1: UART0 reception enabled.
3	TB80	Ninth Transmission Bit. The logic level of this bit will be sent as the ninth transmission bit in 9-bit UART Mode (Mode 1). Unused in 8-bit mode (Mode 0).
2	RB80	Ninth Receive Bit. RB80 is assigned the value of the STOP bit in Mode 0; it is assigned the value of the 9th data bit in Mode 1.
1	TI0	Transmit Interrupt Flag. Set by hardware when a byte of data has been transmitted by UART0 (after the 8th bit in 8-bit UART Mode, or at the beginning of the STOP bit in 9-bit UART Mode). When the UART0 interrupt is enabled, setting this bit causes the CPU to vector to the UART0 interrupt service routine. This bit must be cleared manually by software.
0	RI0	Receive Interrupt Flag. Set to 1 by hardware when a byte of data has been received by UART0 (set at the STOP bit sampling time). When the UART0 interrupt is enabled, setting this bit to 1 causes the CPU to vector to the UART0 interrupt service routine. This bit must be cleared manually by software.

24.2. SPI0 Master Mode Operation

A SPI master device initiates all data transfers on a SPI bus. SPI0 is placed in master mode by setting the Master Enable flag (MSTEN, SPI0CN.6). Writing a byte of data to the SPI0 data register (SPI0DAT) when in master mode writes to the transmit buffer. If the SPI shift register is empty, the byte in the transmit buffer is moved to the shift register, and a data transfer begins. The SPI0 master immediately shifts out the data serially on the MOSI line while providing the serial clock on SCK. The SPIF (SPI0CN.7) flag is set to logic 1 at the end of the transfer. If interrupts are enabled, an interrupt request is generated when the SPIF flag is set. While the SPI0 master transfers data to a slave on the MOSI line, the addressed SPI slave device simultaneously transfers the contents of its shift register to the SPI master on the MISO line in a full-duplex operation. Therefore, the SPIF flag serves as both a transmit-complete and receive-data-ready flag. The data byte received from the slave is transferred MSB-first into the master's shift register. When a byte is fully shifted into the register, it is moved to the receive buffer where it can be read by the processor by reading SPI0DAT.

When configured as a master, SPI0 can operate in one of three different modes: multi-master mode, 3-wire single-master mode, and 4-wire single-master mode. The default, multi-master mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 1. In this mode, NSS is an input to the device, and is used to disable the master SPI0 when another master is accessing the bus. When NSS is pulled low in this mode, MSTEN (SPI0CN.6) and SPIEN (SPI0CN.0) are set to 0 to disable the SPI master device, and a Mode Fault is generated (MODF, SPI0CN.5 = 1). Mode Fault will generate an interrupt if enabled. SPI0 must be manually re-enabled in software under these circumstances. In multi-master systems, devices will typically default to being slave devices while they are not acting as the system master device. In multi-master mode, slave devices can be addressed individually (if needed) using general-purpose I/O pins. Figure 24.2 shows a connection diagram between two master devices in multiple-master mode.

3-wire single-master mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 0. In this mode, NSS is not used, and is not mapped to an external port pin through the crossbar. Any slave devices that must be addressed in this mode should be selected using general-purpose I/O pins. Figure 24.3 shows a connection diagram between a master device in 3-wire master mode and a slave device.

4-wire single-master mode is active when NSSMD1 (SPI0CN.3) = 1. In this mode, NSS is configured as an output pin, and can be used as a slave-select signal for a single SPI device. In this mode, the output value of NSS is controlled (in software) with the bit NSSMD0 (SPI0CN.2). Additional slave devices can be addressed using general-purpose I/O pins. Figure 24.4 shows a connection diagram for a master device in 4-wire master mode and two slave devices.

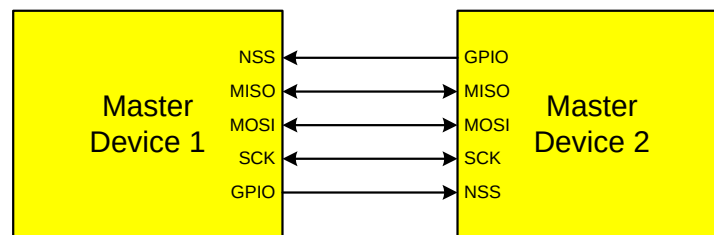


Figure 24.2. Multiple-Master Mode Connection Diagram

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SFR Definition 24.1. SPI0CFG: SPI0 Configuration

Bit	7	6	5	4	3	2	1	0
Name	SPIBSY	MSTEN	CKPHA	CKPOL	SLVSEL	NSSIN	SRMT	RXBMT
Type	R	R/W	R/W	R/W	R	R	R	R
Reset	0	0	0	0	0	1	1	1

SFR Address = 0xA1

Bit	Name	Function
7	SPIBSY	SPI Busy. This bit is set to logic 1 when a SPI transfer is in progress (master or slave mode).
6	MSTEN	Master Mode Enable. 0: Disable master mode. Operate in slave mode. 1: Enable master mode. Operate as a master.
5	CKPHA	SPI0 Clock Phase. 0: Data centered on first edge of SCK period.* 1: Data centered on second edge of SCK period.*
4	CKPOL	SPI0 Clock Polarity. 0: SCK line low in idle state. 1: SCK line high in idle state.
3	SLVSEL	Slave Selected Flag. This bit is set to logic 1 whenever the NSS pin is low indicating SPI0 is the selected slave. It is cleared to logic 0 when NSS is high (slave not selected). This bit does not indicate the instantaneous value at the NSS pin, but rather a de-glitched version of the pin input.
2	NSSIN	NSS Instantaneous Pin Input. This bit mimics the instantaneous value that is present on the NSS port pin at the time that the register is read. This input is not de-glitched.
1	SRMT	Shift Register Empty (valid in slave mode only). This bit will be set to logic 1 when all data has been transferred in/out of the shift register, and there is no new information available to read from the transmit buffer or write to the receive buffer. It returns to logic 0 when a data byte is transferred to the shift register from the transmit buffer or by a transition on SCK. SRMT = 1 when in Master Mode.
0	RXBMT	Receive Buffer Empty (valid in slave mode only). This bit will be set to logic 1 when the receive buffer has been read and contains no new information. If there is new information available in the receive buffer that has not been read, this bit will return to logic 0. RXBMT = 1 when in Master Mode.
Note: In slave mode, data on MOSI is sampled in the center of each data bit. In master mode, data on MISO is sampled one SYSCLK before the end of each data bit, to provide maximum settling time for the slave device. See Table 24.1 for timing parameters.		

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SFR Definition 25.3. TMOD: Timer Mode

Bit	7	6	5	4	3	2	1	0
Name	GATE1	C/T1	T1M[1:0]		GATE0	C/T0	T0M[1:0]	
Type	R/W	R/W	R/W		R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x89

Bit	Name	Function
7	GATE1	Timer 1 Gate Control. 0: Timer 1 enabled when TR1 = 1 irrespective of $\overline{\text{INT1}}$ logic level. 1: Timer 1 enabled only when TR1 = 1 AND $\overline{\text{INT1}}$ is active as defined by bit IN1PL in register IT01CF (see SFR Definition 16.5).
6	C/T1	Counter/Timer 1 Select. 0: Timer: Timer 1 incremented by clock defined by T1M bit in register CKCON. 1: Counter: Timer 1 incremented by high-to-low transitions on external pin (T1).
5:4	T1M[1:0]	Timer 1 Mode Select. These bits select the Timer 1 operation mode. 00: Mode 0, 13-bit Counter/Timer 01: Mode 1, 16-bit Counter/Timer 10: Mode 2, 8-bit Counter/Timer with Auto-Reload 11: Mode 3, Timer 1 Inactive
3	GATE0	Timer 0 Gate Control. 0: Timer 0 enabled when TR0 = 1 irrespective of $\overline{\text{INT0}}$ logic level. 1: Timer 0 enabled only when TR0 = 1 AND $\overline{\text{INT0}}$ is active as defined by bit IN0PL in register IT01CF (see SFR Definition 16.5).
2	C/T0	Counter/Timer 0 Select. 0: Timer: Timer 0 incremented by clock defined by T0M bit in register CKCON. 1: Counter: Timer 0 incremented by high-to-low transitions on external pin (T0).
1:0	T0M[1:0]	Timer 0 Mode Select. These bits select the Timer 0 operation mode. 00: Mode 0, 13-bit Counter/Timer 01: Mode 1, 16-bit Counter/Timer 10: Mode 2, 8-bit Counter/Timer with Auto-Reload 11: Mode 3, Two 8-bit Counter/Timers

26.3.3. High-Speed Output Mode

In High-Speed Output mode, a module's associated CEXn pin is toggled each time a match occurs between the PCA Counter and the module's 16-bit capture/compare register (PCA0CPHn and PCA0CPLn). When a match occurs, the Capture/Compare Flag (CCFn) in PCA0CN is set to logic 1. An interrupt request is generated if the CCFn interrupt for that module is enabled. The CCFn bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. Setting the TOGn, MATn, and ECOMn bits in the PCA0CPMn register enables the High-Speed Output mode. If ECOMn is cleared, the associated pin will retain its state, and not toggle on the next match event.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

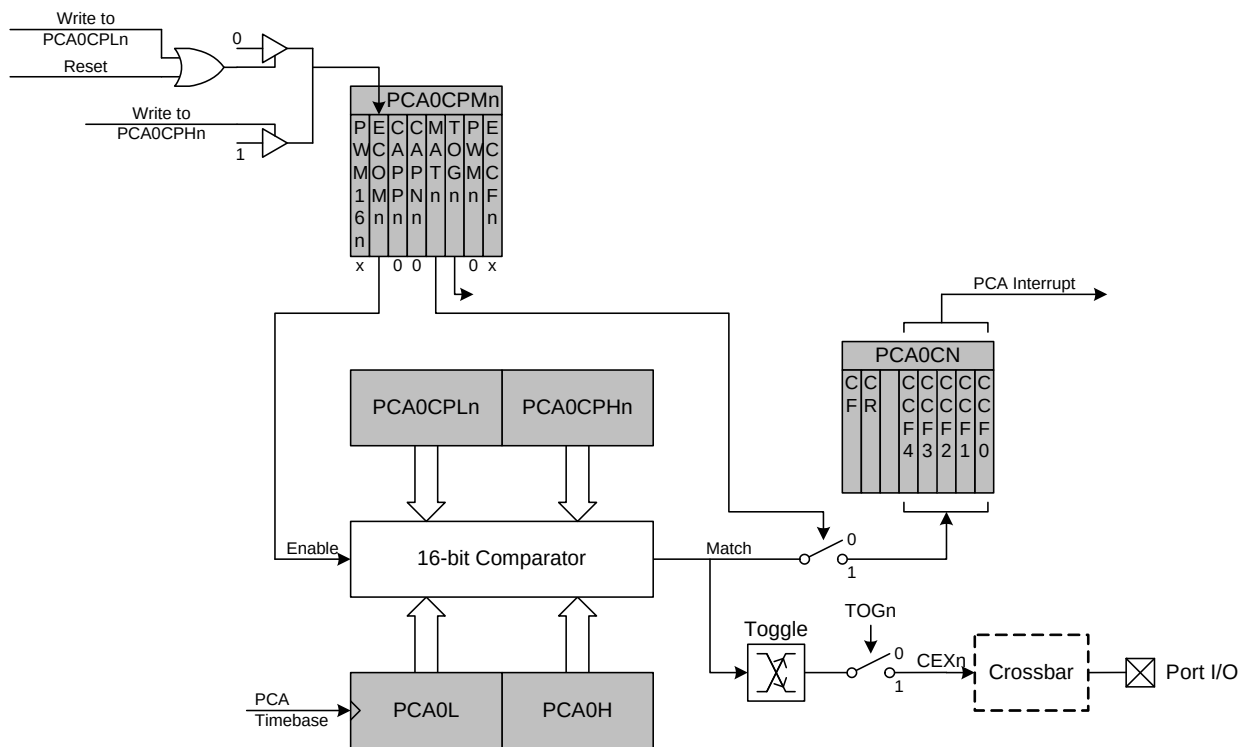


Figure 26.6. PCA High-Speed Output Mode Diagram

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C2 Register Definition 27.10. CRC0: CRC Byte 0

Bit	7	6	5	4	3	2	1	0
Name	CRC[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0xA9

Bit	Name	Function
7:0	CRC[7:0]	CRC Byte 0. A write to this register initiates a 16-bit CRC of one 256-byte block of EPROM memory. The byte written to CRC0 is the upper byte of the 16-bit address where the CRC will begin. The lower byte of the beginning address is always 0x00. When complete, the 16-bit result will be available in CRC1 (MSB) and CRC0 (LSB). See Section “17.3. Program Memory CRC” on page 96.

C2 Register Definition 27.11. CRC1: CRC Byte 1

Bit	7	6	5	4	3	2	1	0
Name	CRC[15:8]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0xAA

Bit	Name	Function
7:0	CRC[15:8]	CRC Byte 1. A write to this register initiates a 32-bit CRC on the entire program memory space. The CRC begins at address 0x0000. When complete, the 32-bit result is stored in CRC3 (MSB), CRC2, CRC1, and CRC0 (LSB). See Section “17.3. Program Memory CRC” on page 96.